

# **RM912**

### CDMA/AMPS 3-4 Volt Power Amplifier (824-849 MHz)

The RM912 dual mode Code Division Multiple Access (CDMA)/Advanced Mobile Phone Service (AMPS) Power Amplifier is a fully matched 6-pin LCC surface mount module designed for mobile units operating in the 824-849 MHz cellular bandwidth. This device meets stringent IS95 CDMA linearity requirements to beyond 28 dBm output power and can be driven to power output levels beyond 31 dBm for high efficiency FM mode operation. A single GaAs Microwave Monolithic Intergrated Circuit (MMIC) contains all active circuitry in the module. The MMIC contains on-board bias circuitry, as well as input and interstage matching circuits. The output match is realized off-chip within the module package to optimize efficiency and power performance into a 50  $\Omega$  load. This device is manufactured with Conexant's GaAs HBT process that provides for all positive voltage DC supply operation while maintaining high efficiency and good linearity. Primary bias to the RM912 can be supplied directly from a three cell nickel-cadmium, single cell lithium-ion, or other suitable battery with output in the 3-4 volt range. Power down is accomplished by setting the voltage on the low current reference pin to zero volts. No external supply side switch is needed as typical "off" leakage is a few microamperes with full primary voltage supplied from the battery.

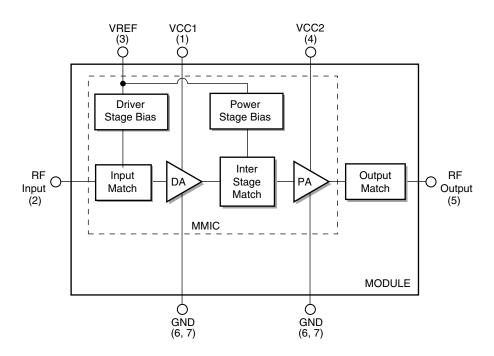
#### **Distinguishing Features**

- Low voltage positive bias supply
- Good linearity
- High efficiency
- Dual mode operation
- Large dynamic range
- 6-pin LCC package (6 x 6 x 1.5 mm)
- · Power down control

### **Applications**

- Digital cellular (CDMA)
- Analog cellular (AMPS)
  - Wireless local loop

#### **Functional Block Diagram**



Electrical Specifications RM912

# **Electrical Specifications**

The following tables list the electrical characteristics of the RM912 Power Amplifier. Table 1 lists the absolute maximum rating for continuous operation. Table 2 lists the recommended operating conditions for achieving the electrical performance listed in Table 3. Table 3 lists the electrical performance of the RM912 Power Amplifier over the recommended operating conditions.

Table 1. Absolute Maximum Ratings<sup>(1)</sup>

Parameter	Symbol	Min	Nominal	Max	Unit
RF Input Power	Pin	_	3.0	6.0	dBm
Supply Voltage	Vcc	_	3.4	5.0	Volts
Reference Voltage	Vref	_	3.0	3.3	Volts
Case Operating Temperature	Tc	-30	25	+110	°C
Storage Temperature	Tstg	<b>–</b> 55	_	+125	°C

#### NOTE(S):

Table 2. Recommended Operating Conditions

Parameter	Symbol	Min	Nominal	Max	Unit
Supply Voltage	Vcc	3.2	3.4	4.2	Volts
Reference Voltage	Vref	2.9	3.0	3.1	Volts
Operating Frequency	Fo	824.0	836.5	849.0	MHz
Operating Temperature	То	-30	+25	+85	°C

<sup>(1)</sup> No damage assuming only one parameter is set at limit at a time with all other parameters set at or below nominal value.

Table 3. Electrical Specifications for CDMA / AMPS Nominal Operating Conditions<sup>(1)</sup>

Characteristics	Condition	Symbol	Min	Typical	Max	Unit
Quiescent current	Vref = 3.0	lq	_	100.0	_	mA
	Vref = 2.9	lq	_	80.0	_	mA
Gain-Digital	Po = 0 dBm	G	26.0	28.0	_	dB
	Po = 28 dBm	$G_p$	27.0	29.0	_	dB
Gain-Analog	Po = 0 dBm	G	26.0	28.0	_	dB
	Po = 31 dBm	Gp	26.0	28.0	_	dB
Power Added Efficiency						
<ul> <li>Analog Mode</li> </ul>	Po = 31 dBm	PAEa	43.0	45.0	_	%
<ul><li>– Digital Mode</li></ul>	Po = 28 dBm	PAEd	32.0	34.0	_	%
Adjacent Channel Power (2)						
– 885 kHz Offset	Po ≤ 28 dBm	ACP1	_	-50.0	-48.0	dBc
–1980 kHz Offset	Po ≤ 28 dBm	ACP2	_	-58.0	-56.0	dBc
Harmonic Suppression						
- Second	Po≤31 dBm	AFo2	_	-42.0	-30.0	dBc
– Third	Po≤31 dBm	AFo3	_	-45.0	-30.0	dBc
Noise Power in RX Band 869-894 MHz	Po @ 28 dBm	RxBN	_	-134.0	-133.0	dBm/Hz
Noise Figure	_	NF	_	6.0	_	dB
Input Voltage Standing Wave Ratio	_	VSWR	_	1.4:1	_	_
Stability (Spurious output)	5:1 VSWR All phases	S	_	_	-60.0	dBc
Ruggedness – No damage	Po≤31 dBm	Ru	10:1	_	_	VSWR

### NOTE(S):

 $<sup>^{(1)}</sup>$  Vcc = +3.4 V, Vref = +3.0 V, Freq = 836.5 MHz, Tc = 25 °C, unless otherwise specified.

<sup>(2)</sup> ACP is specified per IS95 as the ratio of the total in-band power (1.23 MHz BW) to adjacent power in a 30 kHz BW.

**Electrical Specifications** RM912

Table 4. Electrical Specifications Limits for CDMA / AMPS Recommended Operating Conditions<sup>(1)</sup>

Characteristics	Condition	Symbol	Min	Max	Unit
Quiescent current	Vref = 3.0	lq	_	140.0	mA
Gain-Digital	Po = 0 dBm	G	25.0	29.0	dB
	Po = 28 dBm	$G_p$	25.0	32.0	dB
Gain-Analog	Po = 0 dBm	G	25.0	29.0	dB
	Po = 31dBm	Gp	24.0	32.0	dB
Power Added Efficiency					
- Analog Mode	Po = 31 dBm	PAEa	42.0	_	%
<ul><li>– Digital Mode</li></ul>	Po = 28 dBm	PAEd	32.0	_	%
Adjacent Channel Power <sup>(2)</sup>					
– 885 kHz Offset	Po ≤ 28 dBm	ACP1	_	-44.0	dBc
-1980 kHz Offset	Po ≤ 28 dBm	ACP2	_	-56.0	dBc
Harmonic Suppression					
- Second	Po ≤ 31 dBm	AFo2	_	-40.0	dBc
– Third	Po ≤ 31 dBm	AFo3	_	-40.0	dBc
Noise Power in RX Band 869—894 MHz	Po @ 28 dBm	RxBN	_	-131.0	dBm/Hz
Input Voltage Standing Wave Ratio	_	VSWR	_	2:1	_

**NOTE(S):**(1) Per Table 2.

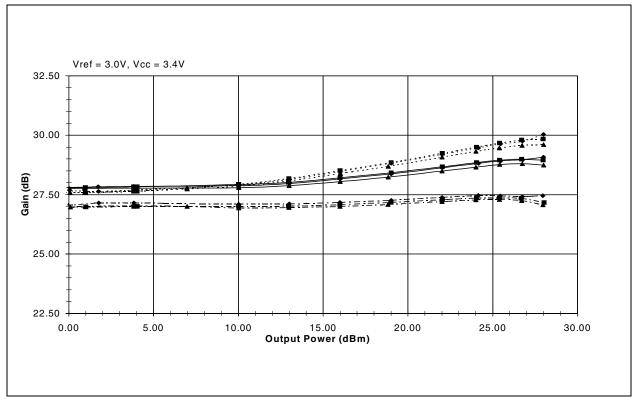
<sup>(2)</sup> ACP is specified per IS95 as the ratio of the total in-band power (1.23 MHz BW) to adjacent power in a 30 kHz BW.

CDMA/AMPS 3-4 Volt Power Amplifier (824-849 MHz)

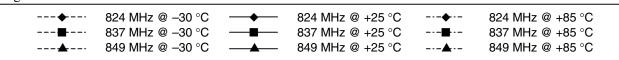
## **Characterization Data**

The following charts illustrate the characteristics of a typical RM912 Power Amplifier tested in the evaluation board described in the following section. The amplifier was selected by characterizing a group of devices and choosing a part with average electrical performance at both nominal and worst case (limit) conditions. Figures 1 through 4 illustrate the digital signal characteristics and Figures 5 through 8 illustrate the analog characteristics of the RM912.

Figure 1. Digital Gain vs. Output Power







Characterization Data RM912

Figure 2. Digital Adjacent Channel Power Magnitude (ACP1) vs. Output Power

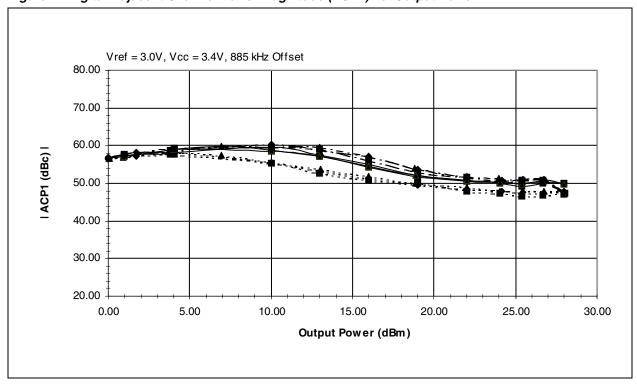
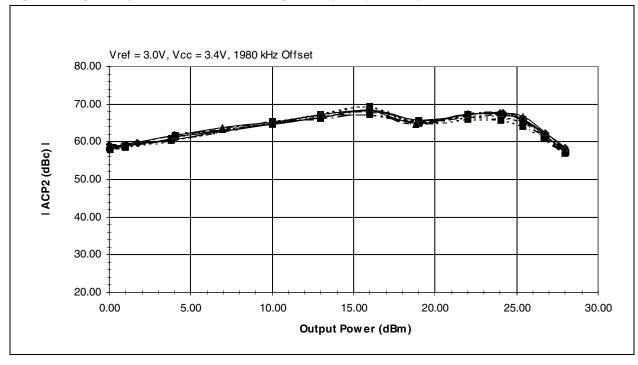


Figure 3. Digital Adjacent Channel Power Magnitude (ACP2) vs. Output Power





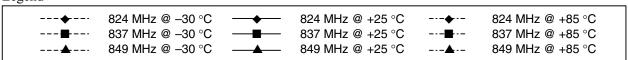


Figure 4. Digital Power Added Efficiency vs. Output Power

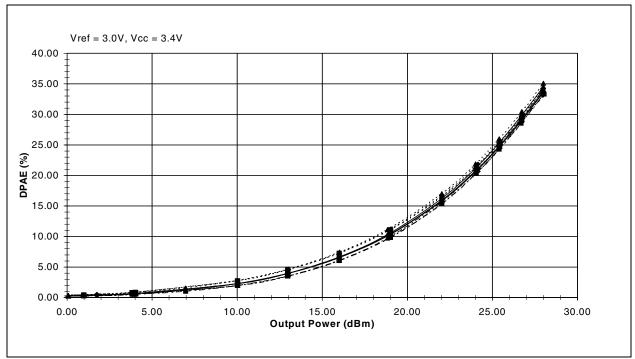
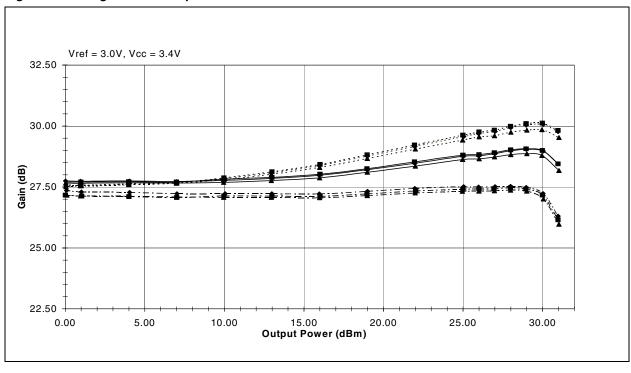


Figure 5. Analog Gain vs. Output Power





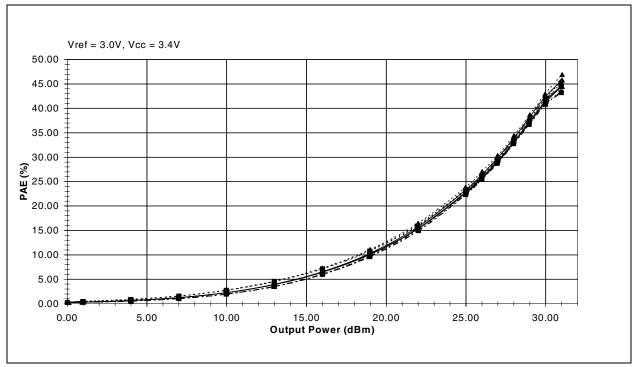


Figure 7. Analog Second Order Harmonic Suppression Magnitude

Legend

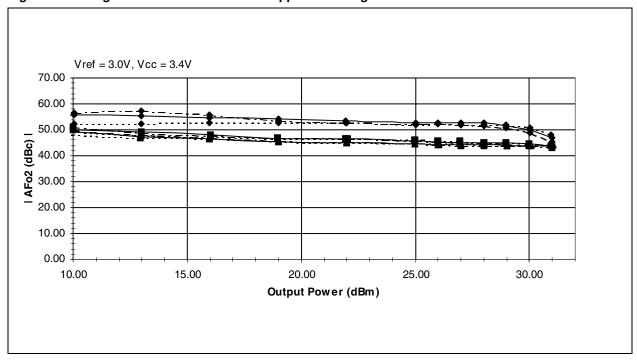
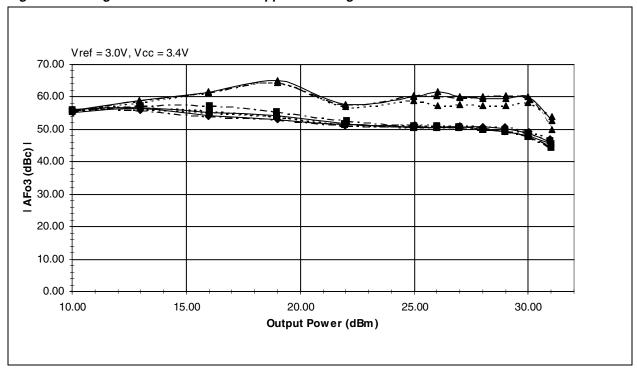
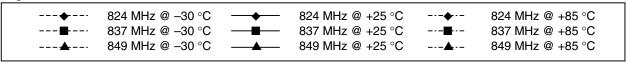


Figure 8. Analog Third Order Harmonic Suppression Magnitude







Characterization Data RM912

Figure 9. Digital Gain vs. Output Power

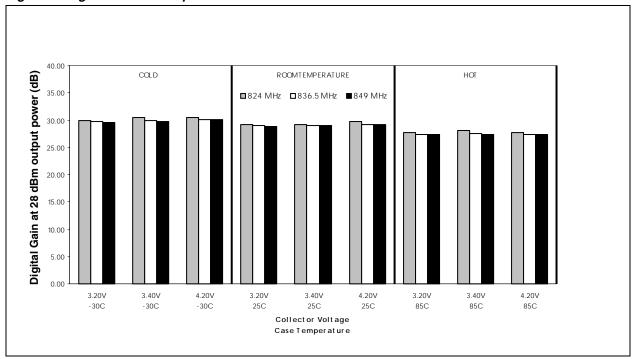


Figure 10. Digital Adjacent Channel Power Magnitude (ACP1) vs. Output Power

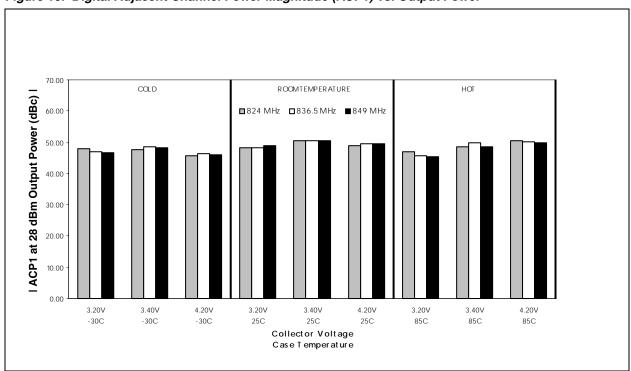


Figure 11. Digital Adjacent Channel Power Magnitude (ACP2) vs. Output Power

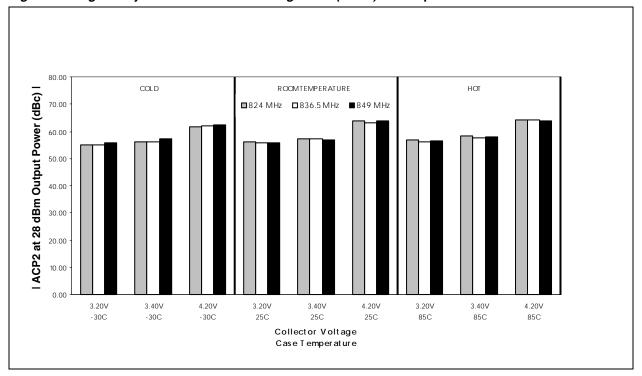
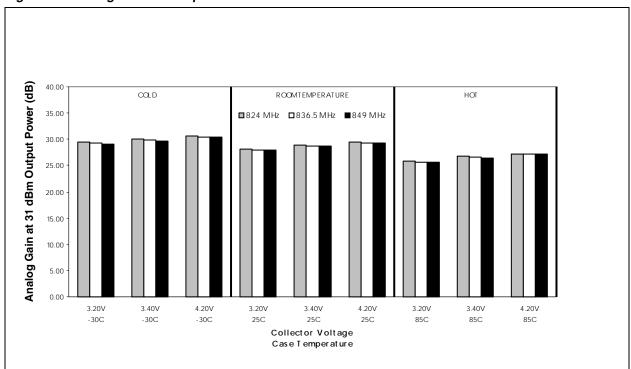


Figure 12. Analog Gain vs. Output Power



Characterization Data RM912

Figure 13. Analog Second Order Harmonic Suppression Magnitude

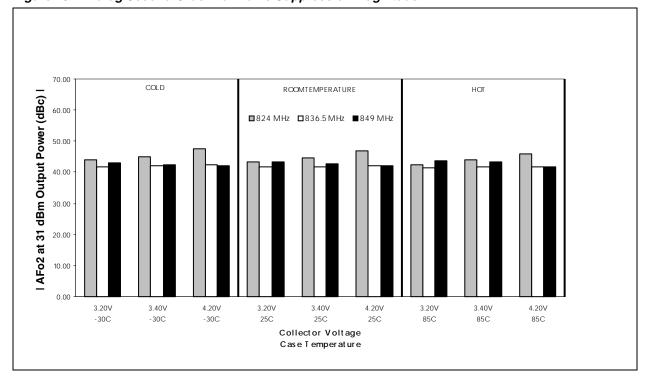


Figure 14. Analog Third Order Harmonic Suppression Magnitude

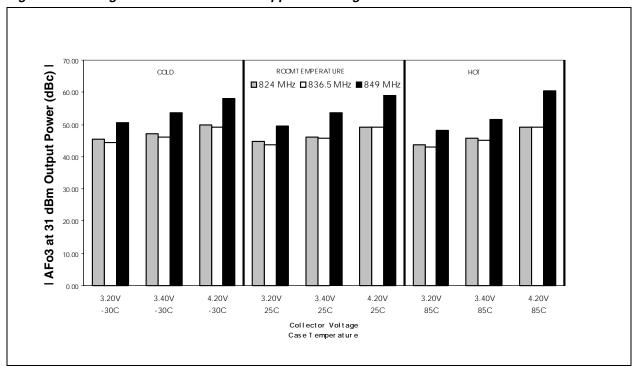


Figure 15. Noise Figure Variation Over Recommended Operating Conditions

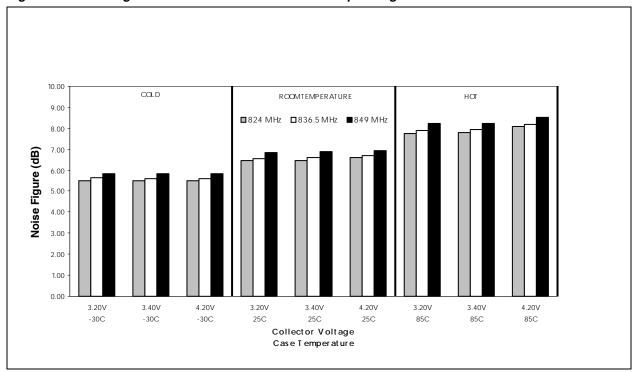
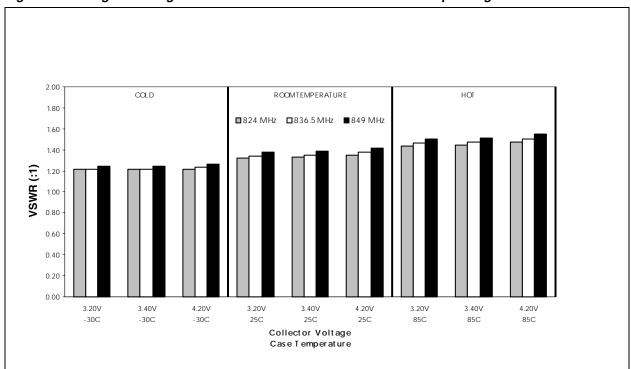


Figure 16. Voltage Standing Wave Ratio Variation Over Recommended Operating Conditions



# **Evaluation Board Description**

The evaluation board is a platform for testing and interfacing design circuitry. To accommodate the interface testing of the RM912, the evaluation board schematic and diagrams are included for preliminary analysis and design. Figure 17 shows the basic schematic of the board for the 824 MHz to 849 MHz range. Figure 18 illustrates the board layout.

Figure 17. Evaluation Board Schematic

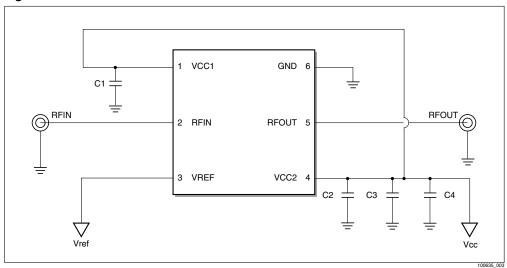
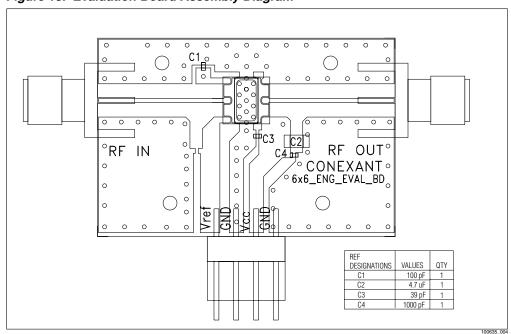


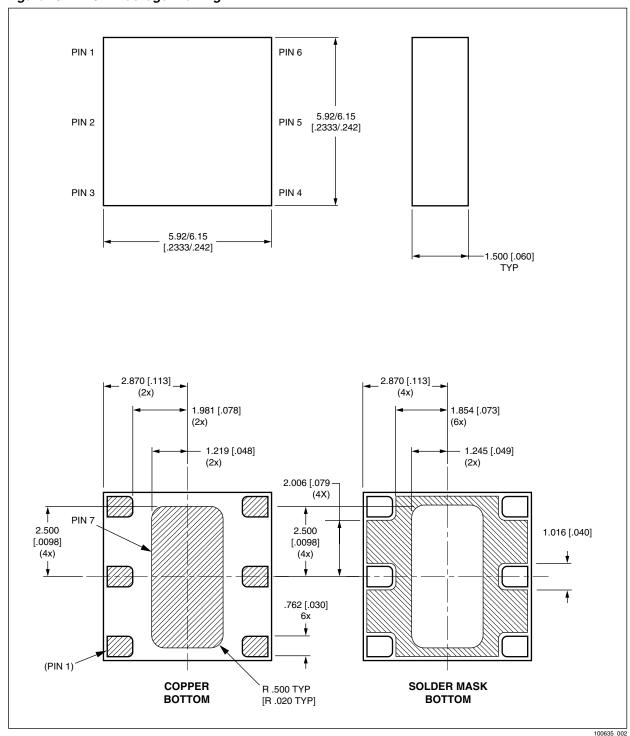
Figure 18. Evaluation Board Assembly Diagram



# **Package Dimensions and Pin Descriptions**

The RM912 is a multi-layer laminate base, overmold encapsulated modular package designed for surface mount solder attachment to a printed circuit board.

Figure 19. RM912 Package Drawing



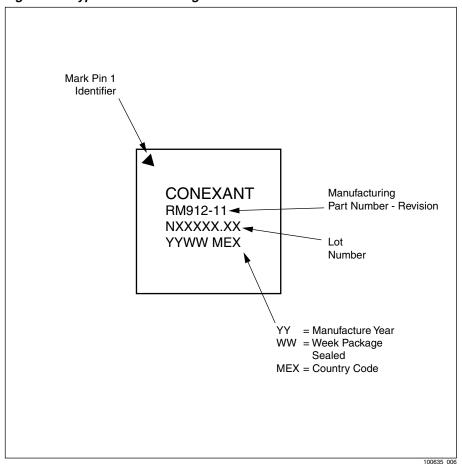
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Table 5. Pin Description

Pin #	Function
1	VCC1 <sup>(1)</sup>
2	RF Input
3	VREF
4	VCC2 <sup>(1)</sup>
5	RF Output
6	GND
7	GND <sup>(2)</sup>

#### NOTE(S):

Figure 20. Typical Case Markings

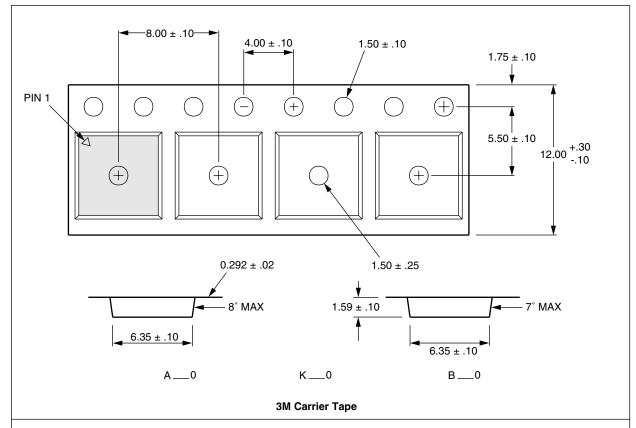


<sup>(1)</sup> All supply pins may be connected together at the supply.

<sup>(2)</sup> Package underside is GND.

Production quantities of this product are shipped in the standard tape-and-reel format illustrated below.

Figure 21. 6 x 6 Tape and Reel



#### NOTE(S):

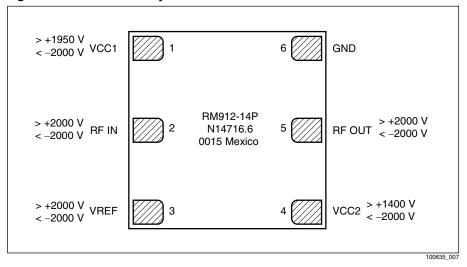
- 1. Carrier tape material: Black conductive polycarbonate.
- 2. Cover tape material: Transparent conductive PSA.
- 3. Cover tape size: 9.3 mm width.
- 4. All dimensions are in millimeters.
- 5. Tolerance:  $XX = \pm .10$ .
- 6. Part No.: 3M048801. (Please indicate on Purchase Order)

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# **Electrostatic Discharge Sensitivity**

The RM912 is a Class I device. Figure 22 lists the Electrostatic Discharge (ESD) immunity level for each pin of the RM912 product. The numbers in Figure 22 specify the ESD threshold level for each pin where the I-V curve between the pin and ground starts to show degradation. The ESD testing was performed in compliance with MIL-STD-883E Method 3015.7 using the Human Body Model. Since 2000 volts represents the maximum measurement limit of the test equipment used, pins marked > 2000 V pass 2000V ESD stress.

Figure 22. ESD Sensitivity Areas



Various failure criteria can be utilized when performing ESD testing. Many vendors employ relaxed ESD failure standards which fail devices only after "the pin fails the electrical specification limits" or "the pin becomes completely non-functional". Conexant employs most stringent criteria, fails devices as soon as the pin begins to show any degradation on a curve tracer.

To avoid ESD damage, latent or visible, it is very important the Class-1 ESD handling precautions listed in Table 6 be used in the product assembly and test areas follow.

Table 6. Precautions for GaAs ICs with ESD Thresholds Greater Than 200V But Less Than 2000V

Personnel Grounding Wrist Straps Conductive Smocks, Gloves and Finger Cots Antistatic ID Badges	Facility Relative Humidity Control and Air Ionizers Dissipative Floors (less than $10^9~\Omega$ to GND)		
Protective Workstation Dissipative Table Tops Protective Test Equipment (Properly Grounded) Grounded Tip Soldering Irons Conductive Solder Suckers Static Sensors	Protective Packaging & Transportation Bags and Pouches (Faraday Shield) Protective Tote Boxes (Conductive Static Shielding) Protective Trays Grounded Carts Protective Work Order Holders		

### **Ordering Information**

Model Number	Manufacturing Part Number	Product Revision	Package	Operating Temperature
_	RM912	-14	6x6LM-6	−30 °C to +85 °C

### **Revision History**

Revision	Level	Date	Description
А		March 2000	Preliminary Information
В		March 2000	Updated Preliminary Information
С		June 2000	Added Characterization Data, Released
D		July 2000	Updated ESD Data
E		July 2000	Preprint Update
F		August 2000	Web Site Update
G		August 2000	Web Format Corrections

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#### **Further Information:**

literature@conexant.com 1-800-854-8099 (North America) 33-14-906-3980 (International)

#### Web Site

www.conexant.com

#### **World Headquarters**

Conexant Systems, Inc. 4311 Jamboree Road, P.O. Box C

Newport Beach, CA 92658-8902 Phone: (949) 483-4600 Fax: (949) 483-6375

#### U.S. Florida/South America

Phone: (727) 799-8406 Fax: (727) 799-8306

#### U.S. Los Angeles

Phone: (805) 376-0559 Fax: (805) 376-8180

#### U.S. Mid-Atlantic

Phone: (215) 244-6784 Fax: (215) 244-9292

#### U.S. North Central

Phone: (630) 773-3454 Fax: (630) 773-3907

#### U.S. Northeast

Phone: (978) 692-7660 Fax: (978) 692-8185

#### U.S. Northwest/Pacific West

Phone: (408) 249-9696 Fax: (408) 249-7113

#### U.S. South Central

Phone: (972) 733-0723 Fax: (972) 407-0639

#### U.S. Southeast

Phone: (919) 858-9110 Fax: (919) 858-8669

#### U.S. Southwest

Phone: (949) 483-9119 Fax: (949) 483-9090

#### **APAC** Headquarters

Conexant Systems Singapore, Pte. Ltd. 1 Kim Seng Promenade Great World City #09-01 East Tower Singapore 237994 Phone: (65) 737 7355 Fax: (65) 737 9077

#### Australia

Phone: (61 2) 9869 4088 Fax: (61 2) 9869 4077

#### China

Phone: (86 2) 6361 2515 Fax: (86 2) 6361 2516

#### Hong Kong

Phone: (852) 2 827 0181 Fax: (852) 2 827 6488

#### India

Phone: (91 11) 692 4780 Fax: (91 11) 692 4712

#### Korea

Phone: (82 2) 565 2880 Fax: (82 2) 565 1440

#### **Europe Headquarters**

Conexant Systems France Les Taissounieres B1 1681 Route des Dolines BP 283 06905 Sophia Antipolis Cedex France

Phone: (33 4) 93 00 33 35 Fax: (33 4) 93 00 33 03

#### **Europe Central**

Phone: (49 89) 829 1320 Fax: (49 89) 834 2734

#### Europe Mediterranean

Phone: (39 02) 9317 9911 Fax: (39 02) 9317 9913

#### **Europe North**

Phone: (44 1344) 486 444 Fax: (44 1344) 486 555

#### **Europe South**

Phone: (33 1) 41 44 36 50 Fax: (33 1) 41 44 36 90

#### Middle East Headquarters

Conexant Systems Commercial (Israel) Ltd. P.O. Box 12660 Herzlia 46733, Israel Phone: (972 9) 952 4064 Fax: (972 9) 951 3924

### Japan Headquarters

Conexant Systems Japan Co., Ltd. Shimomoto Building 1-46-3 Hatsudai, Shibuya-ku, Tokyo 151-0061 Japan Phone: (81 3) 5371 1567 Fax: (81 3) 5371 1501

#### Taiwan Headquarters

Conexant Systems, Taiwan Co., Ltd. Room 2808 International Trade Building 333 Keelung Road, Section 1 Taipei 110, Taiwan, ROC Phone: (886 2) 2720 0282 Fax: (886 2) 2757 6760